

GaAs MMIC PASSIVE DOUBLE-BALANCED MIXER, 4 - 8GHz

Features

RF&LO Frequency: 4~8GHz
IF Frequency: DC~4GHz
LO Input Power: 13dBm
Conversion Loss: 7dB
LO/RF Isolation: 40dB

Chip Size: 1.4mm×0.8mm×0.1mm

General Description

The HG124H-1 is a GaAs pHEMT MMIC passive double-balanced mixer that can be used as an upconverter or downconverter between 4 and 8 GHz. This mixer requires no external components or matching circuitry and supports IF frequency between DC and 4 GHz. Conversion loss is 7dB.

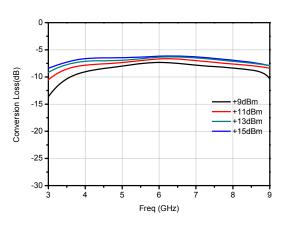
Electrical Specification(T_A =25 \mathcal{C})

Parameter	Min.	Тур.	Max.
Freq. RF&LO(GHz)	4~8		
Freq. IF (GHz)	DC~4		
Conversion Loss(dB)	_	7	_
LO~RF Isolation(dB)	_	40	_
LO~IF Isolation(dB)	_	35	_
RF~IF Isolation(dB)	_	20	ı

Measured Performance

Unless otherwise noted, IF=100MHz.

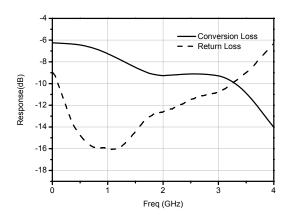
Conversion Loss



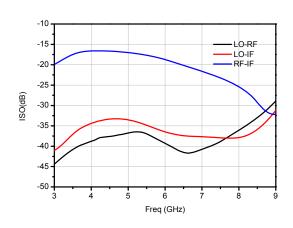
IF Bandwidth

RF: 6GHz LO: 6~10GHz IF: 0.01~4GHz

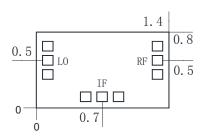
Conversion Loss



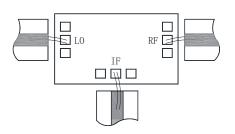
Isolation



Outline Drawing (mm)



Assembly Diagram





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Absolute Maximum Ratings

RF Input Power	+20dBm	
Operating Temperature	-55℃~125℃	
Storage Temperature	-65℃~150℃	

Notes:

- 1. The chip should be stored in a dry and nitrogen environment, and used in a clean environment.
- 2. GaAs material is brittle, can not touch the surface of the chip, must be careful when using.
- 3. The chip is welding with conductive adhesive or alloy (alloy temperature should not exceed 300° C, and no more than 30 sec.), and should make it fully grounded.
- 4.The chip microwave port and substrate gap is not exceeding 0.05mm, with $\Phi25\mu m$ double gold wire bonding, suggested length of gold wire 250 $\sim\!400\mu m.$
- 5. Chip microwave port without DC blocking capacitor.
- 6. The chip is sensitive to static electricity, and should be protected against static electricity during storage and use.